

October 2011

FDD8424H_F085A Dual N & P-Channel PowerTrench[®] MOSFET

FDD8424H_F085A

Dual N & P-Channel PowerTrench[®] MOSFET N-Channel: 40V, 20A, 24m Ω P-Channel: -40V, -20A, 54m Ω

Features

Q1: N-Channel

- Max $r_{DS(on)}$ = 24m Ω at V_{GS} = 10V, I_D = 9.0A
- Max r_{DS(on)} = 30mΩ at V_{GS} = 4.5V, I_D = 7.0A

Q2: P-Channel

- Max $r_{DS(on)}$ = 54m Ω at V_{GS} = -10V, I_D = -6.5A
- Max $r_{DS(on)}$ = 70m Ω at V_{GS} = -4.5V, I_D = -5.6A
- Fast switching speed
- Qualified to AEC Q101
- RoHS Compliant



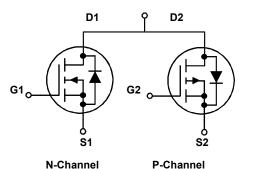
General Description

These dual N and P-Channel enhancement mode Power MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench- process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

Application

- Inverter
- H-Bridge





Dual DPAK 4L

MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

| Symbol | Parameter | Q1 | Q2 | Units | | | |
|-----------------------------------|--|--------------------------------|--------|-------|-----|--|--|
| V _{DS} | Drain to Source Voltage | | 40 | -40 | V | | |
| V _{GS} | Gate to Source Voltage | | ±20 | ±20 | V | | |
| Ι _D | Drain Current - Continuous (Package Limited) | | 20 | -20 | | | |
| | - Continuous (Silicon Limited) | T _C = 25°C | 26 | -20 | | | |
| | - Continuous | T _A = 25°C | 9.0 | -6.5 | - A | | |
| | - Pulsed | | 55 | -40 | | | |
| P _D | Power Dissipation for Single Operation | T _C = 25°C (Note 1) | 30 | 35 | | | |
| | T _A = 25°C (Note | | 3.1 | | W | | |
| | | $T_A = 25^{\circ}C$ (Note 1b) | 1.3 | | | | |
| E _{AS} | Single Pulse Avalanche Energy | (Note 3) | 29 | 33 | mJ | | |
| T _J , T _{STG} | Operating and Storage Junction Temperature Range | | -55 to | +150 | °C | | |

Thermal Characteristics

| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Single Operation for Q1 | (Note 1) | 4.1 | °C/W |
|---------------------|---|----------|-----|------|
| $R_{	ext{	heta}JC}$ | Thermal Resistance, Junction to Case, Single Operation for Q2 | (Note 1) | 3.5 | 0/10 |

Package Marking and Ordering Information

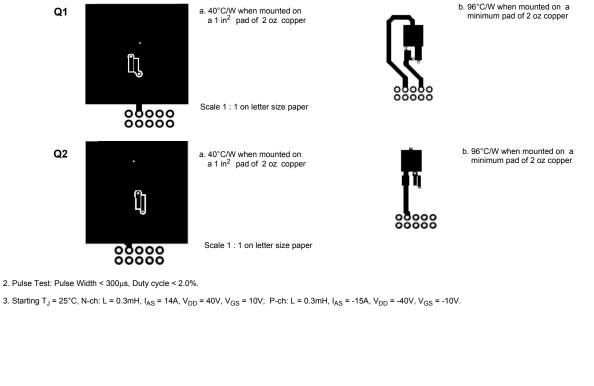
| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|----------------|-----------|-----------|------------|------------|
| FDD8424H | FDD8424H_F085A | TO-252-4L | 13" | 12mm | 2500 units |

©2011 Fairchild Semiconductor Corporation FDD8424H_F085A Rev.B1

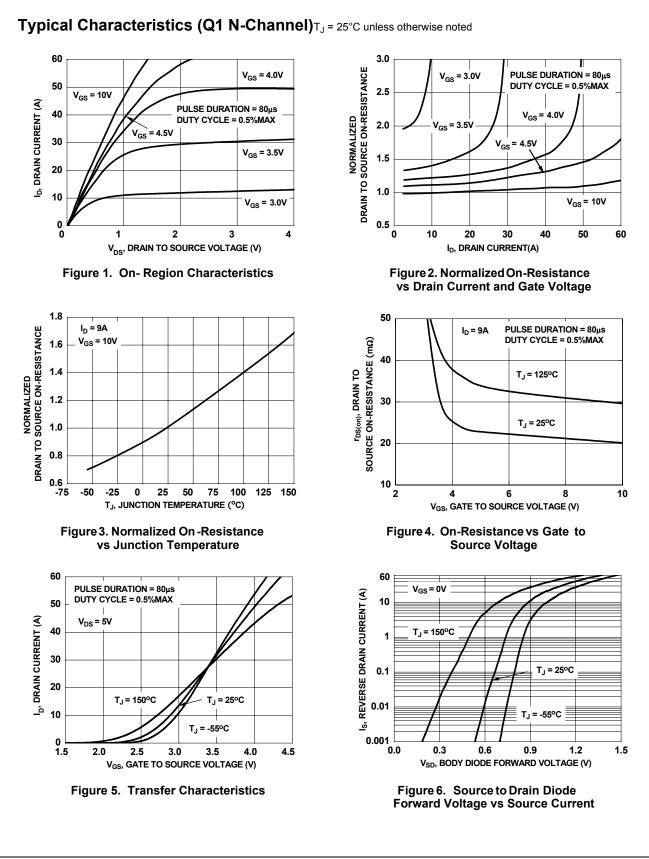
| Symbol | Parameter | Test Conditions | Туре | Min | Тур | Max | Units |
|--|---|---|----------|-----------|----------------|----------------|----------|
| Off Chara | acteristics | | | | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | $I_D = 250 \mu A, V_{GS} = 0V$ $I_D = -250 \mu A, V_{GS} = 0V$ | Q1 Q2 | 40 -40 | | | V |
| $\frac{\Delta BV_{DSS}}{\Delta T_{,l}}$ | Breakdown Voltage Temperature Coefficient | $I_D = 250 \mu$ A, referenced to 25°C $I_D = -250 \mu$ A, referenced to 25°C | Q1 Q2 | | 34 -32 | | mV/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 32V, V_{GS} = 0V$ $V_{DS} = -32V, V_{GS} = 0V$ | Q1 Q2 | | | 1 -1 | μA |
| I _{GSS} | Gate to Source Leakage Current | $V_{GS} = \pm 20V, V_{DS} = 0V$ | Q1 Q2 | | | ±100 ±100 | nA nA |
| On Chara | octeristics | | <u> </u> | <u> </u> | <u> </u> | | 1 |
| V _{GS(th)} | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}, I_D = 250 \mu A$ $V_{GS} = V_{DS}, I_D = -250 \mu A$ | Q1 Q2 | 1 -1 | 1.7 -1.6 | 3 -3 | V |
| $\frac{\Delta V_{\text{GS(th)}}}{\Delta T_{\text{J}}}$ | Gate to Source Threshold Voltage Temperature Coefficient | I_D = 250µA, referenced to 25°C I_D = -250µA, referenced to 25°C | Q1 Q2 | | -5.3 4.8 | | mV/°C |
| r | Static Drain to Source On Resistance | $V_{GS} = 10V, I_D = 9.0A V_{GS} = 4.5V, I_D = 7.0A V_{GS} = 10V, I_D = 9.0A, T_J = 125^{\circ}C$ | Q1 | | 19 23 29 | 24 30 37 | - mΩ |
| r _{DS(on)} | State Drain to Source On Resistance | $ \begin{array}{l} V_{GS} = -10V, \ I_D = -6.5A \\ V_{GS} = -4.5V, \ I_D = -5.6A \\ V_{GS} = -10V, \ I_D = -6.5A, \ T_J = 125^\circ C \end{array} $ | Q2 | | 42 58 62 | 54 70 80 | 11152 |
| 9 _{FS} | Forward Transconductance | $V_{DS} = 5V, I_D = 9.0A$ $V_{DS} = -5V, I_D = -6.5A$ | Q1 Q2 | | 29 13 | | S |
| Dynamic | Characteristics | | | | | | |
| C _{iss} | Input Capacitance | Q1 V _{DS} = 20V, V _{GS} = 0V, f = 1MHZ | Q1 Q2 | | 750 1000 | 1000 1330 | pF |
| C _{oss} | Output Capacitance | Q2 | Q1 Q2 | | 115 140 | 155 185 | pF |
| C _{rss} | Reverse Transfer Capacitance | V _{DS} = -20V, V _{GS} = 0V, f = 1MHZ | Q1 Q2 | | 75 75 | 115 115 | pF |
| R _g | Gate Resistance | f = 1MHz | Q1 Q2 | | 1.1 3.3 | | Ω |
| Switching | g Characteristics | | | | | | |
| t _{d(on)} | Turn-On Delay Time | Q1 | Q1 Q2 | | 7 7 | 14 14 | ns |
| t _r | Rise Time | V_{DD} = 20V, I _D = 9.0A, V_{GS} = 10V, R _{GEN} = 6 Ω | Q1 Q2 | | 13 3 | 24 10 | ns |
| t _{d(off)} | Turn-Off Delay Time | Q2 V _{DD} = -20V, I _D = -6.5A, | Q1 Q2 | | 17 20 | 31 36 | ns |
| t _f | Fall Time | $V_{GS} = -10V, R_{GEN} = 6\Omega$ | Q1 Q2 | | 6 3 | 12 10 | ns |
| <u>^</u> | Total Gate Charge | | Q1 Q2 | | 14 17 | 20 24 | nC |
| Q _{g(TOT)} | | V _{GS} = 10V, V _{DD} = 20V, I _D = 9.0A | Q1 | | 2.3 | | - |
| Q _{g(TOT)} Q _{gs} | Gate to Source Charge | Q2 | Q2 | | 3.0 | | nC |

©2011 Fairchild Semiconductor Corporation FDD8424H_F085A Rev.B1

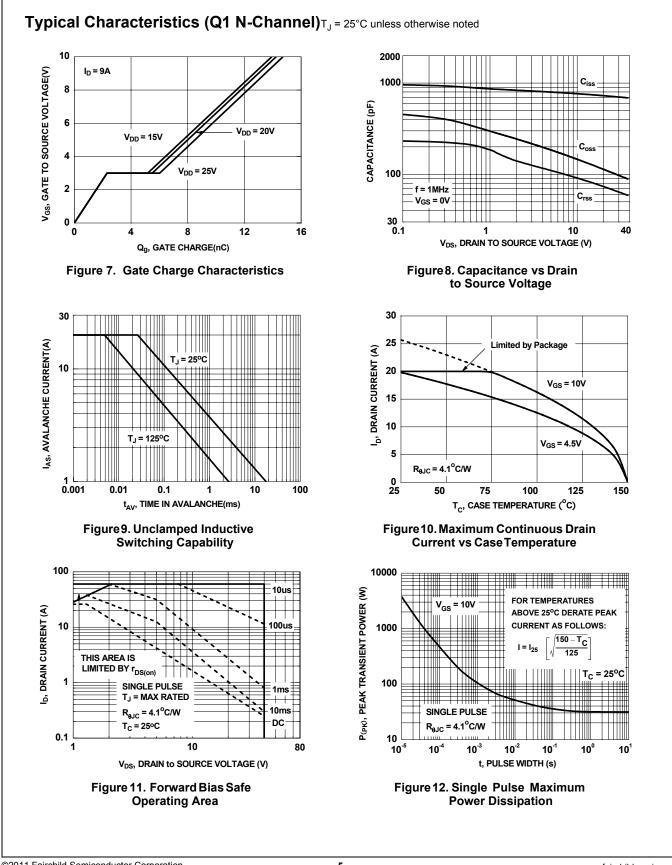
| | ce Diode Characteristics | | | | | |
|-------------------|---------------------------------------|---|----------|--------------|-------------|----|
| | | | | | | |
| V _{SD} | Source to Drain Diode Forward Voltage | $V_{GS} = 0V, I_S = 9.0A$ (Note 2) $V_{GS} = 0V, I_S = -6.5A$ (Note 2) | Q1 Q2 | 0.87 0.88 | 1.2 -1.2 | V |
| t _{rr} I | Reverse Recovery Time | Q1 I _F = 9.0A, di/dt = 100A/s | Q1 Q2 | 25 29 | 38 44 | ns |
| Q _{rr} I | Reverse Recovery Charge | Q2 I _F = -6.5A, di/dt = 100A/s | | 19 29 | 29 44 | nC |



©2011 Fairchild Semiconductor Corporation FDD8424H_F085A Rev.B1

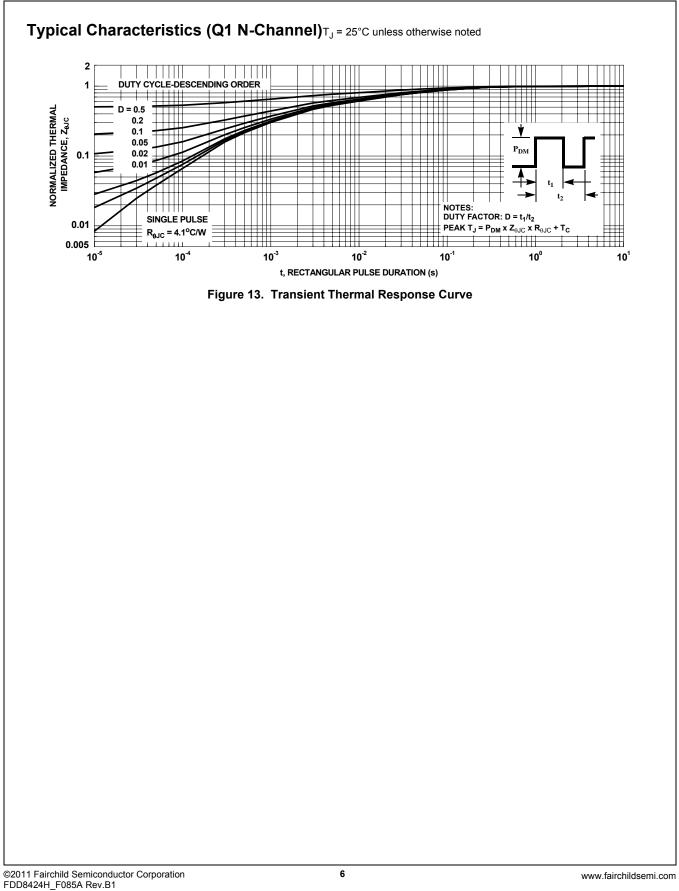


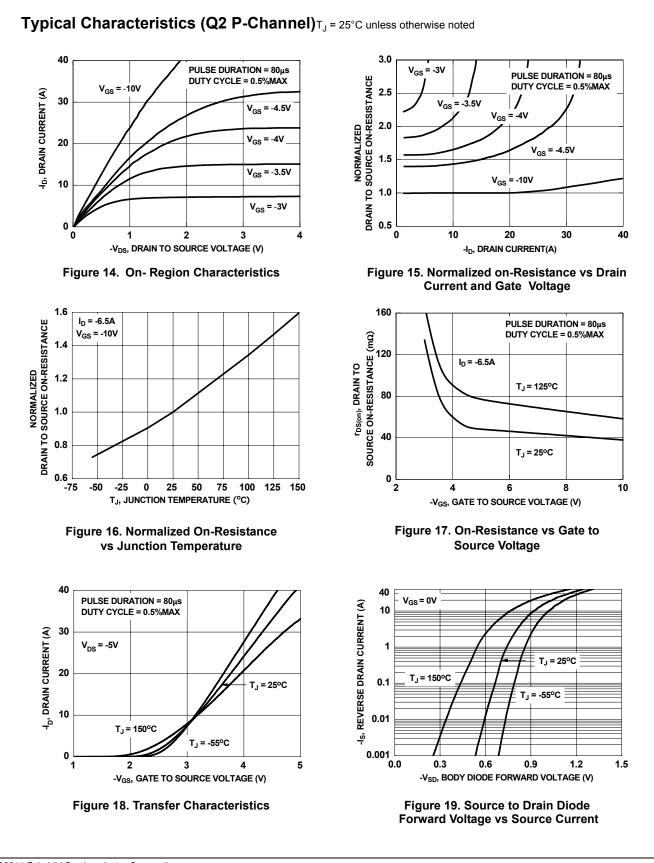
@2011 Fairchild Semiconductor Corporation FDD8424H_F085A Rev.B1



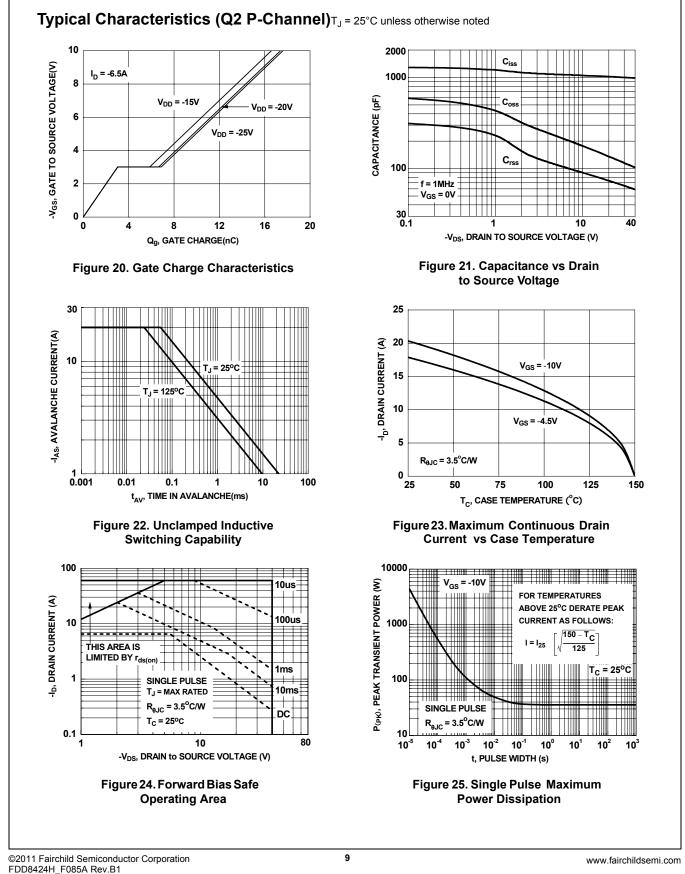
©2011 Fairchild Semiconductor Corporation FDD8424H_F085A Rev.B1

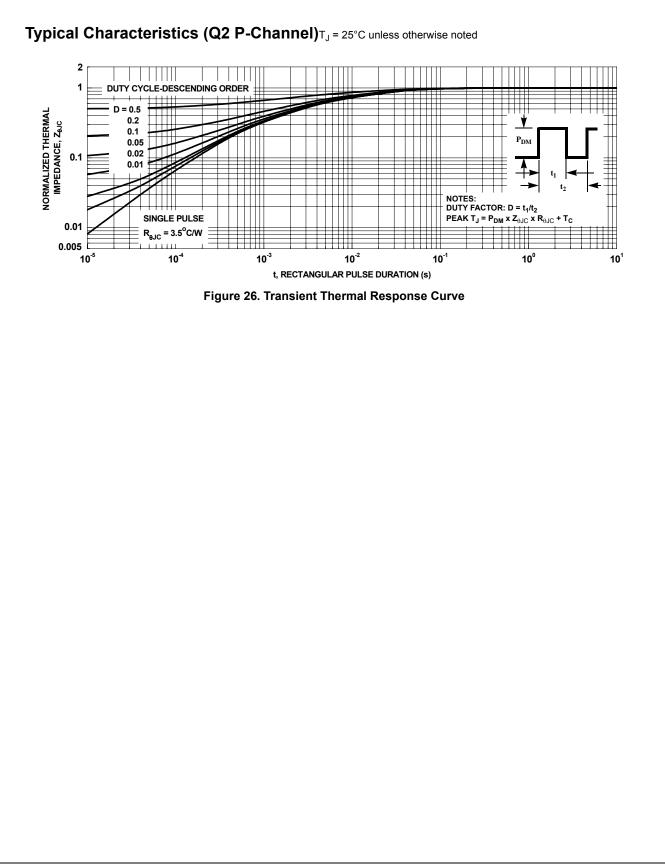
FDD8424H_F085A Dual N & P-Channel PowerTrench[®] MOSFET



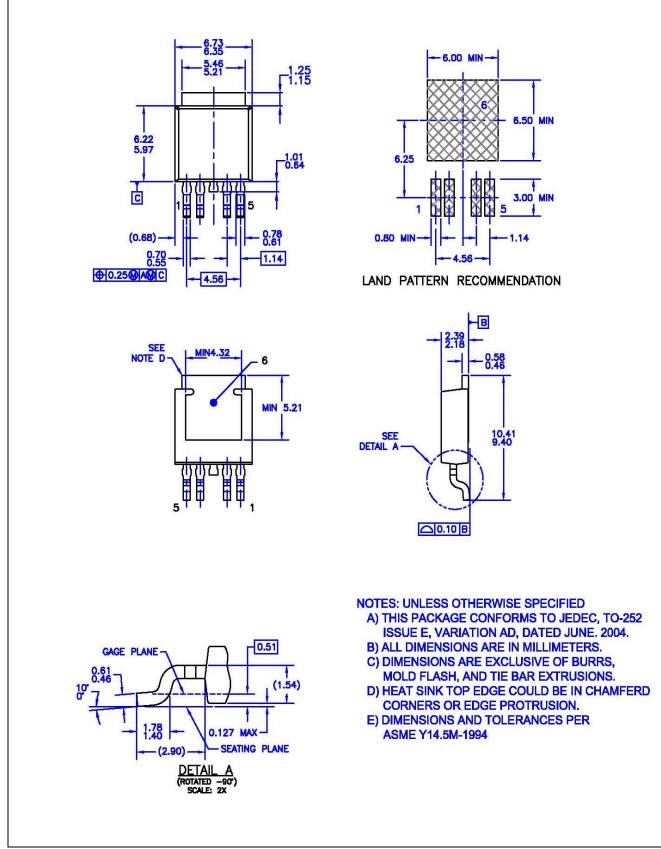


©2011 Fairchild Semiconductor Corporation FDD8424H_F085A Rev.B1





FDD8424H_F085A Dual N & P-Channel PowerTrench[®] MOSFET



©2011 Fairchild Semiconductor Corporation FDD8424H_F085A Rev.B1



SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

2Cool™ AccuPower™ Auto-SPM™ AX-CAP™* BitSiC[®] Build it Now[™] CorePLUS™ CorePOWER™ CROSSVOLT™ CTL™ Current Transfer Logic™ DEUXPEED® Dual Cool™ EcoSPARK[®] EfficentMax™ ESBC™

Fairchild Semiconductor®

FACT Quiet Series™ FACT[®]

Global Power ResourceSM Green FPS™ Green FPS™ e-Series™ G*max*™ GTO™ IntelliMAX™ ISOPLANAR™ MegaBuck™ MICROCOUPLER™ MicroFET™ MicroPak™ MicroPak2™ MillerDrive™ MotionMax™ Motion-SPM™ mWSaver™ OptiHiT™

FlashWriter[®] *

FPS™ F-PFS™

FRFET®

PDP SPM™ Power-SPM™ PowerTrench[®] PowerXS™ Programmable Active Droop™ OFFT QS™ Quiet Series™ RapidConfigure™ тм Saving our world, 1mW/W/kW at a time™ SignalWise™ SmartMax™ SMART START™ SPM[®] STEALTH™ SuperFET[®] SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS[®] SyncFET™ Sync-Lock™ GENERAL ®*

bwer p franchise TinyBoost™ TinyBuck™ TinyCalc™ TinyLogic® TINYOPTO™ TinyPower™ TinyPWM™ TinyWire™ TranSiC® TriFault Detect™ TRUECURRENT®* μSerDes™ UHC® Ultra FRFET™ UniFET™ VCX™ VisualMax™

XS™

The Power Franchise[®]

The Right Technology for Your Success™

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

OPTOLOGIC[®]

R

OPTOPLANAR[®]

DISCLAIMER

₣

Fairchild®

FAST®

FastvCore™

FETBench™

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in

- Life support devices or systems are devices or systems which, (a) are 1. intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or 2. system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

| Datasheet Identification | Product Status | Definition | | | | |
|--|-----------------------|---|--|--|--|--|
| Advance Information | Formative / In Design | Datasheet contains the design specifications for product development. Specifications may change in any manner without notice. | | | | |
| Preliminary | First Production | Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design. | | | | |
| No Identification Needed Full Production | | Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design. | | | | |
| Obsolete | Not In Production | Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only. | | | | |